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cket No.: LEE.118

U.S. DEPARTMENT OF COMMERCE Patent and Trademark Office

OMB No. 0651-0 27 (exp.5/51/2002)	Patent and Trademark Office			
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Tab settings → → ▼ ▼ ▼ ▼ ▼ To the Director of the United States Patent and Trademark Of	fice: Please record the attached original documents or copy thereof.			
1. Name of conveying party(ies): Min-Lung HUANG Ching-Huei SU Wei-Chung WANG Jian-Wen LO Po-Jen CHENG Chian-Chi LIN Kuo-Chung YEE Additional names(s) of conveying party(ies)	2. Name and address of receiving party(ies): Name: Advanced Semiconductor Engineering, Inc. Address: 26 Chin 3rd Road, Nantze Export Processing Zone			
3. Nature of conveyance:				
☑ Assignment				
☐ Security Agreement ☐ Change of Name	City: Kaohsiung State/Prov.:			
☐ Other	Country: Taiwan R.O.C. ZIP:			
Execution Date: December 15, 2006	Additional name(s) & address(es) ☐ Yes ☒ No			
Patent Application No. Filing date NEW December 26, 2006	B. Patent No.(s)			
Additional numbers	☐ Yes ☒ No			
5. Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:			
Name: Andrew J. Telesz, Jr.	7. Total fee (37 CFR 3.41):\$ 40.00			
Registration No. 33,581	☐ Enclosed - Any excess or insufficiency should be			
Address: Volentine Francos & Whitt, P.L.L.C.	credited or debited to deposit account			
11951 Freedom Drive, Suite 1260	Authorized to be charged to deposit account			
	8. Deposit account number:			
City: Reston State/Prov.: VA	50-0238			
Country: U.S.A. ZIP: 20190	(Attach duplicate copy of this page if paying by deposigecount)			
20 110	TUSE THIS SPACE			

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is true copy of the original document.

Andrew J. Telesz, Jr.

Name of Person Signing

Total number of pages including cover sheet, attachments, and document:

December 36, 2006

Dates

ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned

Insert	
Name(s)	of
Inventor	(s)

- 1. Min-Lung HUANG 5. Ching-Huei SU
- 2. Wei-Chung WANG 6. Jian-Wen LO
- 3. Po-Jen CHENG 7. Chian-Chi LIN
- 4. Kuo-Chung YEE 8.

Insert Name(s) of Assignee(s) & the undersigned hereby sell(s) and assign(s) to

Advanced Semiconductor Engineering, Inc.

Address(es)

of 26 Chin 3rd Road, Nantze Export Processing Zone Kaohsiung, Taiwan R.O.C.

(hereinafter designated as the Assignee) the entire right, title and interest for the United States as defined in 35 USC 100, in the invention known as

Title of Invention

Three-Dimensional Package And Method Of Making The Same

Date of Signing of Application for which an application for patent in the United States of America has been executed by

the undersigned on 15 December 2006

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuing, division or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

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PATENT REEL: 018738 FRAME: 0415 The undersigned hereby grant(s) to Adam C. Volentine, Reg. No. 33,289 and William S. Francos, Reg. No. 38,456, and the firm of VOLENTINE FRANCOS, P.L.L.C. the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date	15 December 2006	Signature of Inventor	* Min- Lung Humg
			Min-Lung HUANG
Date	15 December 2006	Signature of Inventor	* areochy hy
Date	15 December 2006	Signature of Inventor	Wei-Chung WANG
Date		Digmentale of the order	Po-Jen CHENG
Date	15 December 2006	Signature of Inventor	* Luo-ching fie Kuo-Chung YEE
Date	15 December 2006	Signature of Inventor	* Ching-Huei Su Ching-Huei SU
Date	15 December 2006	Signature of Inventor	* Jian - Wen Lo Jian-Wen LO
Date	15 December 2006	Signature of Inventor	* Chian-Chi-CTA
Date		Signature of Inventor	

(Note regarding Witnessing: It is recommended that the execution by the Inventor(s) be witnessed by at least two witnesses who sign here. However, the current practice of the U.S. Patent and Trademark Office is to record an Assignment even it has not been witnessed.)

Witness			
Witness	·····		·

Applicant Reference No. A01727/US9869-HMG Attorney Docket No. LEE. 118

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